OCTOBER 1976 - REVISED MARCH 1988

- Synchronous Load
- Direct Overriding Clear
- Parallel to Serial Conversion

| ТҮРЕ | TYPICAL MAXIMUM CLOCK FREQUENCY | TYPICAL POWER DISSIPATION |
|-------------|------------------------------------|------------------------------|
| '166 | 35 MHz | 360 mW |
| 'I S166A | 35 MHz | 100 mW |

description

The '166 and 'LS166A 8-bit shift registers are compatible with most other TTL logic families. All '166 and 'LS166A inputs are buffered to lower the drive requirements to one Series 54/74 or Series 54LS/74LS standard load, respectively. Input clamping diodes minimize switching transients and simplify system design.

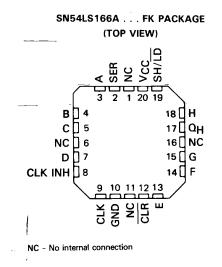
These parallel-in or serial-in, serial-out shift registers have a complexity of 77 equivalent gates on a monolithic chip. They feature gated clock inputs and an overriding clear input. The parallel-in or serial-in modes are established by the shift/load input. When high, this input enables the serial data input and couples the eight flip-flops for serial shifting with each clock pulse. When low, the parallel (broadside) data inputs are enabled and synchronous loading occurs on the next clock pulse. During parallel loading, serial data flow is inhibited. Clocking is accomplished on the low-to-high-level edge of the clock pulse through a two-input positive NOR gate permitting one input to be used as a clock-enable or clock-inhibit function. Holding either of the clock inputs high inhibits clocking; holding either low enables the other clock input. This, of course, allows the system clock to be free-running and the register can be stopped on command with the other clock input. The clock inhibit input should be changed to the high level only while the clock input is high. A buffered, direct clear input overrides all other inputs, including the clock, and sets all flip-flops to zero.

| FUNCTION TABL |
|---------------|
|---------------|

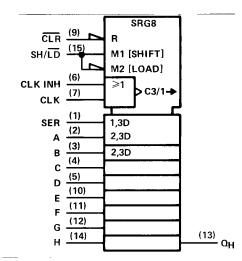
| · · · · · | | 18 | PUTS | | | INTE | RNAL | |
|-----------|--------|---------|-------|---------|----------|-----------------|-----------------|--------------------------|
| | SHIFT/ | CLOCK | СТОСК | SERIAL | PARALLEL | | PUTS | OUTPUT Q _H |
| - | LOAD | INHIBIT | 02000 | oenine. | АН | QA | α _B | -H |
| L | × | x | х | х | × | L | L | L |
| н | x | L | L | x | x | Q _{A0} | Q _{B0} | QHO |
| н | L | Ł | t | × | ah | а | b | h |
| н | н | L | t | н | x | н | ۵ _{An} | QGn |
| н | н | L | t | L | х | L | QAn | QGn |
| н | x | н | t | x | х | Q _{A0} | 0 ₈₀ | α _{н0} |

| SN54166, SN54LS166A J OR W PACKAGE | |
|------------------------------------|--|
| SN74166 N PACKAGE | |
| SN74LS166A D OR N PACKAGE | |
| (TOP VIEW) | |
| | |

| SER Ц1 | \bigcirc 16 | P*UU |
|---------|---------------|------------|
| A [] 2 | 15 | SH/LD |
| в 🛛 з | 14 | □н |
| c∏₄ | 13 | □он |
| D 🗌 5 | 12 | □G |
| | 11 | ΠF |
| CLK 🔲 7 | 10 | Π Ε |
| | 9 | |
| | | |



logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

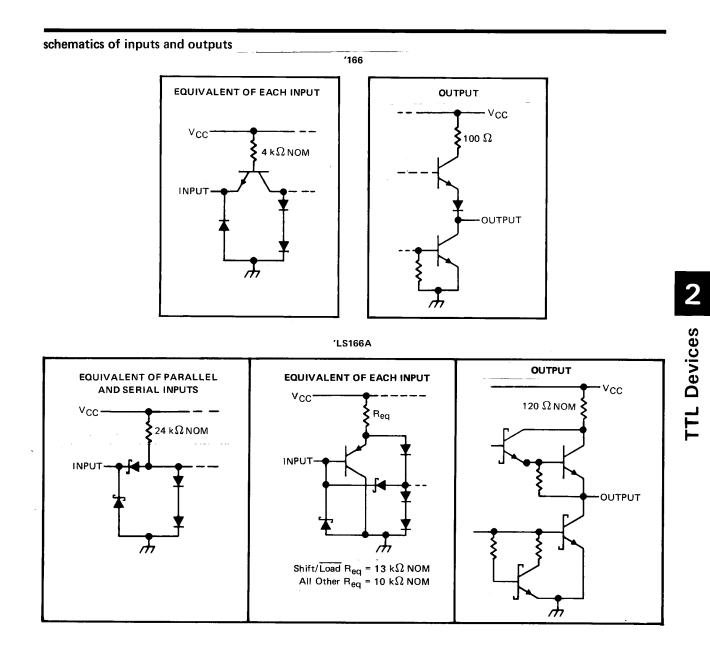


typical clear, shift, load, inhibit, and shift sequences

I L H L SERIAL SHIFT I -2 I **TTL Devices** Ē н I Ī I I _ ÷ _ SERIAL SHIFT т 60 c o ò SERIAL INPUT SHIFT/LOAD ۲ ш ц. CLOCK INHIBIT CLEAR оитрит о_н PARALLEL INPUTS



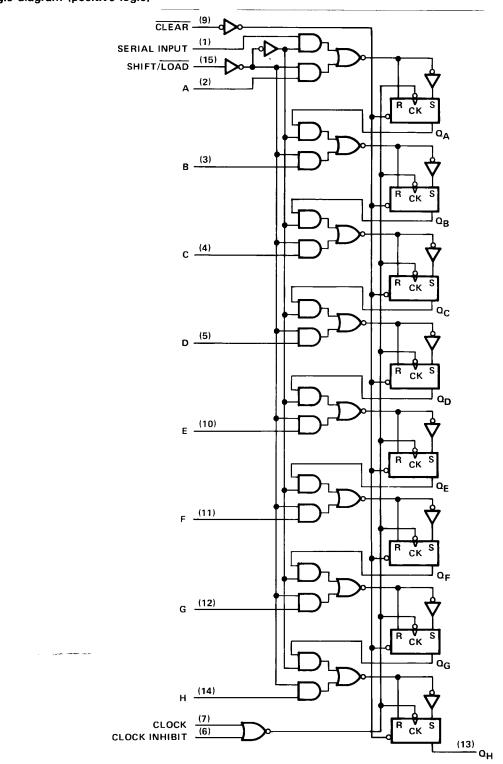
CLEAR





and an and an and

logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.



SN54166, SN74166 PARALLEL-LOAD 8-BIT SHIFT REGISTERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) . | | | | • • | | • • | | • | | | | 7 V |
|---------------------------------------|---------|---------|---------|-----|------|-----|--|---|-----|------|--------|--------|
| Input voltage | | | | • | | | | | | | | 5.5 V |
| Operating free-air temperature range: | SN54166 | (see No | te 2) . | | | | | • | | -55° | °C to | 125°C |
| | SN74166 | | | | | . • | | • | • • | . (|)°C to | ა 70°C |
| Storage temperature range | | | | ••• | | | | • | - | -65° | °C to | 150°C |
| recommended operating conditions | | | | | | | | | | | | |

| | 5 | s | | | | | |
|--|-----|-----|------|------|-----|------|-----|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| Supply voltage, V _{CC} | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| High-level output current, IOH | | | -800 | | | -800 | μA |
| Low-level output current, IOL | | | 16 | | | 16 | mA |
| Clock frequency, fclock | 0 | | 25 | 0 | | 25 | MHz |
| Width of clock or clear pulse, tw (see Figure 1) | 20 | | | 20 | | | ns |
| Mode-control setup time, t _{su} | 30 | | | 30 | | | ns |
| Data setup time, t _{su} (see Figure 1) | 20 | | | 20 | | | ns |
| Hold time at any input, th (see Figure 1) | 0 | | | 0 | | | ns |
| Operating free-air temperature, TA (see Note 2) | 55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | | TEST CONDITIONS [†] |) s | SN5416 | 6 | s | | | |
|-----|--|--|-----|--------|------|-----|------|------|------|
| | PARAMETER | TEST CONDITIONS | | TYP‡ | MAX | MIN | TYP‡ | MAX | UNIT |
| VIH | High-level input voltage | | 2 | | | 2 | | | V |
| VIL | Low-level input voltage | | | | 0.8 | | | 0.8 | V |
| VIĶ | Input clamp voltage | $V_{CC} = MIN, I_I = -12 \text{ mA}$ | 1 | | -1.5 | | | -1.5 | V |
| VOH | High-level output voltage | $V_{CC} = MIN, V_{IH} = 2 V,$ $V_{IL} = 0.8 V, I_{OH} = -800 \mu A$ | 2.4 | 3.4 | | 2.4 | 3.4 | | v |
| VOL | Low-level output voltage | $V_{CC} = MIN, V_{IH} = 2V,$ $V_{IL} = 0.8V, I_{OL} = 16 mA$ | | 0.2 | 0.4 | | 0.2 | 0.4 | v |
| 4 | Input current at maximum input voltage | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | - 1 | mA |
| Чн | High-level input current | V _{CC} = MAX, V _I = 2.4 V | 1 | | 40 | | | 40 | μA |
| μL | Low-level input current | V _{CC} = MAX, V _I = 0.4 V | | | -1.6 | | | -1.6 | mA |
| los | Short-circuit output current§ | V _{CC} = MAX | -20 | | -57 | -18 | | -57 | mA |
| ICC | Supply current | V _{CC} = MAX, See Note 3 | | 90 | 127 | | 90 | 127 | mA |

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

\$Not more than one output should be shorted at a time.

NOTES: 1. Voltage values are with respect to network ground terminal.

- 2. An SN54166 in the W package operating at free-air temperatures above 113° C⁻requires a heat-sink that provides a thermal resistance from case to free air, R_{0CA}, of not more than 48° C/W.
- 3. With all outputs open, 4.5 V applied to the serial input, all other inputs except the clock grounded, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to the clock.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

| PARAMETER | | PARAMETER TEST CONDITIONS | | TYP | MAX | UNIT |
|-----------|---|--|----|-----|-----|------|
| max | Maximum clock frequency | | 25 | 35 | | MHz |
| PHL | Propagation delay time, high-to- low-level output from clear | 0 15 - F - 10 - 10 () | | 23 | 35 | ns |
| PHL | Propagation delay time, high-to- low-level output from clock | CL = 15 pF, RL = 400 քչ, See Figure 1 | | 20 | 30 | ns |
| | Propagation delay time, low-to- high-level output from clock | | | 17 | 26 | ns |



TTL Devices

2-533

SN54LS166A, SN74LS166A **PARALLEL·LOAD 8-BIT SHIFT REGISTERS**

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) | 7V |
|--|--------------|
| Input voltage | 7V |
| Operating free-air temperature range: SN54LS166A | |
| SN74LS166A | |
| Storage temperature range | 5°C to 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

| | SN54LS166A | | | SN54LS166A SN74LS166A | | | |
|--|--|--|--|--|--|---|---|
| | MIN | ТҮР | MAX | MIN | ТҮР | MAX | |
| Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| High-level input voltage | 2 | | | 2 | | | V |
| Low-level input voltage | | | 0.7 | | | 0.8 | 1 v |
| High-level output current | | | - 0.4 | | | - 0.4 | mA |
| Low-level output current | | | 4 | | | 8 | mA |
| Clock frequency | 0 | | 25 | 0 | | 25 | MHz |
| Width of clear pulse (See Figure 1) | 20 | | | 20 | | | ns |
| Width of clock pulse (See Figure 1) | 25 | | | 25 | | | 1 |
| Mode-control setup time | 30 | | | 30 | | | ns |
| Data setup time (See Figure 1) | 20 | | 1 | 20 | | | ns |
| Hold time at any input (See Figure 1 and Note 4) | 0 | | | 0 | | | ns |
| Operating free air temperature | - 55 | | 125 | 0 | , <u> </u> | 70 | °c |
| | High-level input voltage Low-level input voltage High-level output current Low-level output current Clock frequency Width of clear pulse (See Figure 1) Width of clock pulse (See Figure 1) Mode-control setup time Data setup time (See Figure 1) Hold time at any input (See Figure 1 and Note 4) | MINSupply voltage4.5High-level input voltage2Low-level input voltage2High-level output current2Low-level output current2Clock frequency0Width of clear pulse (See Figure 1)20Width of clock pulse (See Figure 1)25Mode-control setup time30Data setup time (See Figure 1)20Hold time at any input (See Figure 1 and Note 4)0 | MINTYPSupply voltage4.55High-level input voltage2Low-level input voltage2High-level output current | MINTYPMAXSupply voltage4.555.5High-level input voltage22Low-level input voltage-0.7High-level output currentLow-level output current-4Clock frequency025Width of clear pulse (See Figure 1)20Width of clock pulse (See Figure 1)25Mode-control setup time30Data setup time (See Figure 1)20Hold time at any input (See Figure 1 and Note 4)0 | MINTYPMAXMINSupply voltage4.555.54.75High-level input voltage222Low-level input voltage0.7High-level output current0.7Low-level output current0.4Clock frequency0250Width of clear pulse (See Figure 1)2020Width of clock pulse (See Figure 1)2525Mode-control setup time3030Data setup time (See Figure 1 and Note 4)00 | MINTYPMAXMINTYPSupply voltage4.555.54.755High-level input voltage2222Low-level input voltage0.40.40.4Low-level output current0.40.40.4Low-level output current0.40.40.4Clock frequency0250Width of clear pulse (See Figure 1)2020Width of clock pulse (See Figure 1)2525Mode-control setup time3030Data setup time (See Figure 1)2020Hold time at any input (See Figure 1 and Note 4)00 | MIN TYP MAX MIN TYP MAX Supply voltage 4.5 5 5.5 4.75 5 5.25 High-level input voltage 2 2 2 2 2 0.8 Low-level input voltage -0.4 -0.4 -0.4 -0.4 -0.4 Low-level output current -0.4 4 8 8 Clock frequency 0 25 0 25 Width of clear pulse (See Figure 1) 20 20 20 20 25 Mode-control setup time 30 |

NOTE 4: The hold time limit of 0 ns applies only if the rise time is less than or equal to 10 ns.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITION | et | SN | SN | 66A | | | | |
|-----------|---|----------|------|------|-------|------|------|-------|-----|
| | | | MIN | TYP‡ | MAX | MIN | түр‡ | MAX | |
| VIK | V _{CC} = MIN, I _I = − 18 mA | | | | - 1.5 | | | - 1.5 | V |
| ∨он | $V_{CC} = MIN, V_{IH} = 2 V, V_I$ $I_{OH} = -0.4 \text{ mA}$ | L = MAX, | 2.5 | 3.4 | | 2.7 | 3.4 | | V |
| N.S. | V _{CC} = MIN, V _{IH} = 2 V, I _O | L = 4 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | |
| VOL | VIL = MAX | L≈8mA | | | | | 0.35 | 0.5 | - × |
| 4 | V _{CC} = MAX, V _I = 7 V | | | | 0.1 | | | 0.1 | mA |
| ЧН | V _{CC} = MAX, V _I = 2.7 V | | | | 20 | | | 20 | μΑ |
| ΊL | V _{CC} = MAX, V _I = 0.4 V | <u> </u> | | | - 0.4 | | | - 0.4 | mA |
| IOSS | V _{CC} = MAX | | - 20 | | - 100 | - 20 | | - 100 | mA |
| Icc | V _{CC} = MAX, See Note 5 | | | 20 | 32 | | 20 | 32 | mA |

tFor conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. 1 \pm All typical values are at V_{CC} = 5 V, T_A = 25°C.

\$Not more than one output should be shorted at a time, and duration for short-circuit should not exceed one second.

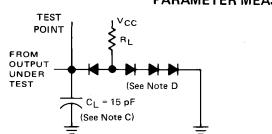
NOTE 5: With all outputs open, 4.5 V applied to the serial input and all other inputs except the clock grounded, ICC is measured after a momentary ground, than 4.5 V, is applied to clock.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--|-----|-----|-----|------|
| f _{max} Maximum clock frequency | | 25 | 35 | | MHz |
| Propagation delay time, high-to- ^t PHL low-level output from clear | | - | 19 | 30 | ns |
| Propagation delay time, high-to- tPHL low-level output from clock | $C_L = 15 \text{ pF}, R_L = 2 \text{ k}\Omega,$ See Figure 1 | 7 | 14 | 25 | ns |
| Propagation delay time, low-to- ^t PLH high-level output from clock | | 5 | 11 | 20 | ns |



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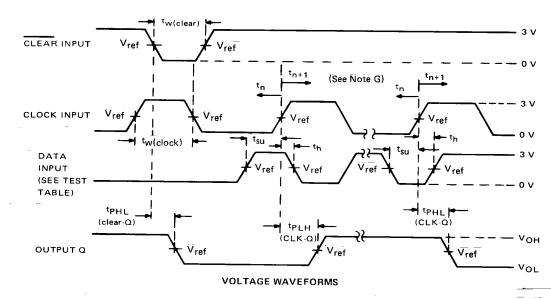


LOAD FOR OUTPUT UNDER TEST

PARAMETER MEASUREMENT INFORMATION

TEST TABLE FOR SYNCHRONOUS INPUTS

| DATA INPUT FOR TEST | SHIFT/LOAD | OUTPUT TESTED (SEE NOTE F) |
|------------------------|------------|------------------------------------|
| н | 0 V | Q _H at t _{n+1} |
| Serial Input | 4.5 V | Q _H at t _{n+8} |



NOTE: A. All pulse generators have the following characteristics: $Z_{out} \approx 50\Omega$; for '166, $t_r \leq 7$ ns and $t_f \leq 7$ ns; for 'LS166A, $t_r \leq 15$ ns and $t_f \leq 6$ ns.

- B. The clock pulse has the following characteristics: $t_{w(clock)} \le 20$ ns and PRR = 1 MHz. The clear pulse has the following characteristics: $t_{w(clear)} \le 20$ ns and t_{hold} = 0 ns. When testing f_{max} , vary the clock PRR.
- C. CL includes probe and jig capacitance.
- D. All diodes are 1N3064, 1N916, or equivalent.
- E. A clear pulse is applied prior to each test.
- F. Propagation delay times (tPLH and tPHL) are measured at tn + 1. Proper shifting of data is verified at tn + 8 with a functional test.
- G. $t_n = bit$ time before clocking transition
 - t_{n+1} = bit time after one clocking transition
 - $t_{n+8} = bit$ time after eight clocking transitions
- H. For '166 V_{ref} = 1.5 V; for 'LS166A V_{ref} = 1.3 V.

FIGURE 1

2





PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|----------------------------------|---------|
| 5962-9558301QEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9558301QE A SNJ54166J | Samples |
| 5962-9558301QFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9558301QF A SNJ54166W | Samples |
| 5962-9558301QFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9558301QF A SNJ54166W | Samples |
| 8001701EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8001701EA SNJ54LS166AJ | Samples |
| 8001701EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8001701EA SNJ54LS166AJ | Samples |
| 8001701FA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8001701FA SNJ54LS166AW | Samples |
| 8001701FA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8001701FA SNJ54LS166AW | Samples |
| JM38510/30609B2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30609B2A | Samples |
| JM38510/30609B2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30609B2A | Samples |
| JM38510/30609BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30609BEA | Samples |
| JM38510/30609BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30609BEA | Samples |
| M38510/30609B2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30609B2A | Samples |
| M38510/30609B2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30609B2A | Samples |
| M38510/30609BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30609BEA | Samples |
| M38510/30609BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30609BEA | Samples |



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| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|----------------------------------|---------|
| SN54166J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54166J | Samples |
| SN54166J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54166J | Samples |
| SN54LS166AJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS166AJ | Samples |
| SN54LS166AJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS166AJ | Samples |
| SN74LS166AD | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS166A | Samples |
| SN74LS166AD | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS166A | Samples |
| SN74LS166ADR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS166A | Samples |
| SN74LS166ADR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS166A | Samples |
| SN74LS166AN | ACTIVE | PDIP | Ν | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS166AN | Samples |
| SN74LS166AN | ACTIVE | PDIP | Ν | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS166AN | Samples |
| SN74LS166ANSR | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS166A | Samples |
| SN74LS166ANSR | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS166A | Samples |
| SNJ54166J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9558301QE A SNJ54166J | Samples |
| SNJ54166J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9558301QE A SNJ54166J | Samples |
| SNJ54166W | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9558301QF A SNJ54166W | Samples |
| SNJ54166W | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9558301QF A SNJ54166W | Samples |
| SNJ54LS166AFK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54LS 166AFK | Samples |

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|---------------------------|---------|
| SNJ54LS166AFK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54LS 166AFK | Samples |
| SNJ54LS166AJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8001701EA SNJ54LS166AJ | Samples |
| SNJ54LS166AJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8001701EA SNJ54LS166AJ | Samples |
| SNJ54LS166AW | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8001701FA SNJ54LS166AW | Samples |
| SNJ54LS166AW | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8001701FA SNJ54LS166AW | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN54LS166A, SN74LS166A :

- Catalog : SN74LS166A
- Military : SN54LS166A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

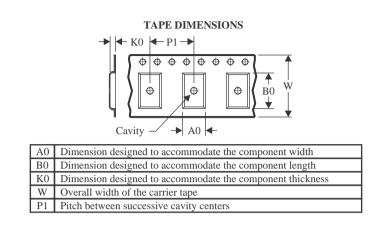


Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| SN74LS166ADR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LS166ANSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |



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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS166ADR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |
| SN74LS166ANSR | SO | NS | 16 | 2000 | 356.0 | 356.0 | 35.0 |

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

| *All dimensions are nomir | nal |
|---------------------------|-----|
|---------------------------|-----|

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9558301QFA | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| 8001701FA | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| JM38510/30609B2A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| M38510/30609B2A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| SN74LS166AD | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74LS166AN | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS166AN | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54166W | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| SNJ54LS166AFK | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| SNJ54LS166AW | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP2-F16



J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



NS0016A



PACKAGE OUTLINE

SOP - 2.00 mm max height

SOP



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- Per ASME Y14.5M.
 This drawing is subject to change without notice.
 This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



NS0016A

EXAMPLE BOARD LAYOUT

SOP - 2.00 mm max height

SOP



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



NS0016A

EXAMPLE STENCIL DESIGN

SOP - 2.00 mm max height

SOP



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N**) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



4211283-4/E 08/12

D (R-PDSO-G16) PLASTIC SMALL OUTLINE Stencil Openings (Note D) Example Board Layout (Note C) –16x0,55 -14x1,27 -14x1,27 16x1,50 5,40 5.40 Example Non Soldermask Defined Pad Example Pad Geometry (See Note C) 0,60 .55 Example 1. Solder Mask Opening (See Note E) -0,07 All Around

NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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